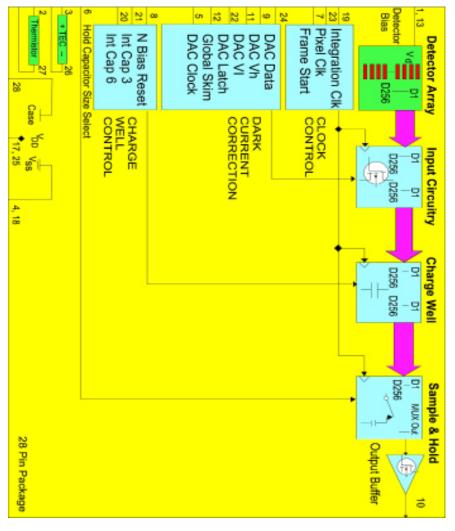
### Cal Sensors 256 Element Multiplexed Array **Functional Diagram**



#### **USB Interface Board Features & Specifications**

■ USB interface to controller Can be controlled by software commands with supplied driver ■ Simple command structure interface • On-board microcontroller controls all multiplexed array functions Cooler control to set point temperature All multiplexed timing and control voltages Detector bias voltage A/D converter control Storage of all control and correction coefficients in non-volatile memory Automatic reload at power-up ■ 16 bit A/D conveter at 500k samples/sec Efficient, high current PWM cooler drive FET requires no additional heatsinking Synchronization with A/D conversion ensures low noise ■ Simple power requirements 12V@100mA 4 to 6 volts @1.5A ■ Small size: 2.1" x 1.4" x 0.4" Direct interface to standard 28 pin package

### **Contact Information:**

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Visit our website... www.calsensors.com

Our Sales Representative Near You:



**1-5 μm** 

## LIRA<sup>5S</sup> **256 Element Multiplexed Arrays for** Thermography and Thermal Imaging

# Lead Selenide (PbSe)



### **PbSe Multiplexed Array Features:**

- The low profile package features a detector with square pixels on 50 micron centers.
- The internal electronics provide variable integration and dark current correction.
- Temperature stabilization is achieved using an internal thermoelectric cooler and thermistor.
- This product is designed for thermography and thermal imaging applications in the 1 to 5 micron wavelength region.
- The internal multiplexer includes a serial readout up to 4 MHz and a global plus 8 bit per pixel dark current correction.
- Signal integration is variable with adjustable well size and can be generated before or during readout.
- The array package is supplied with a compact USB controller board (optional) for easy computer interface.
- Can be supplied as a development system.

### **256 Element PbSe Multiplexed Array Performance**

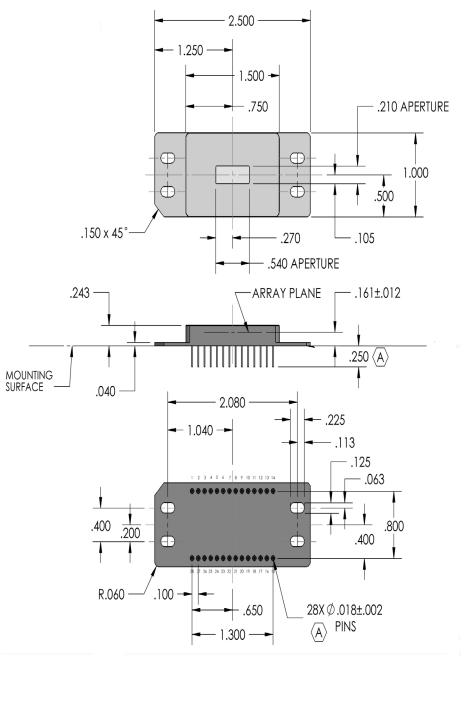
### **Parameter:**

**Operating Wavelength Range:** Number of Elements: Element Size:

Peak Detectivity: Resistance Uniformity (pixel-to-pixel): Integration Range: Pixel Clock: Linearity: Pixel Operability: Detector Rise Time: Input Power Requirement:

#### **Typical Performance:** 1 to 5 Microns

256 detector elements Pixel size 40 microns square, and pitch 50 microns  $D^*$ : 1.0 x10<sup>10</sup> (Jones)  $\pm 15\%$  of array signal mean .01mS to 200mS (on board) 2MHz max. for 4MHz data output 90% 98% minimum <10µS 7 VDC mux, 8VDC cooler 1.7A max



#### **PIN FUNCTION**

		19 INT CLK	10 MUX OUT	<b>1 DETECTOR BIAS</b>	
ī		20 NC	11 DAC VI	<b>2 THERMISTOR A</b>	
		21 NC	12 GLOBAL SKIM	3 TEC (+)	
PIXEL CLK	PIXEL C	22 DAC LOAD CLK	13 DET BIAS	4 NC	
		23 PIXEL CLK	14 NO CONNECTION	5 SERIAL CLK	
LK	INT CL	24 SERIAL DATA	<b>15 NO CONNECTION</b>	6 CFG LOAD CLK	
		25 NC	<b>16 NO CONNECTION</b>	7 FRAME START	
START FRAME		26 TEC (-)	17 Vdd	8 N BIAS RST	
	FRAM	<b>27 THERMISTOR B</b>	18 Vss	9 DAC Vh	
		28 CASE			

See website for descriptions of pin functions.



